ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® MAterial Composition © Copyright 2005. IPC, Bar international and Pan-Ameri	nockburn, Illinois. A	Il rights reserved un ntions.	nder both	This docume level parts, t	ent is a declar he declaratior	ation of the s	substances es all lowe	within the manufac r level materials for	turer listed which the	item. No manufac	ote: if the cturer has	item is an ass engineering r	sembly with lower esponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information									
Supplier Information														
Company name* Company unique ID			ID Unique II			ue ID Authority				Response Date*				
onsemi	onsemi								2023-0	2023-06-08				
Contact Name Title - Contact]	Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Authorized Representative* Title - Representative			Phone -			- Representative*			Email	Email - Representative*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number Mf	r Item Number	Mfr Item Name		·	Effective Da	te Versior	n]	Manufacturing Site		Weight	*	UOM	Unit Type	
CA	AT5132ZI-10-GT3 DPP, 15V, 128		TAPS, I2C		2023-06-08		,	TH6		25.27		mg	Each	
Manufacturing Proccess Information										1		1	-	
Terminal Plating / Grid Array Material	Terminal Base	Ferminal Base Alloy		L Rating	Peak Process Body Temperat		Temperatu	ure Max Time at Peak Tempe		ature Number of Reflow Cycles		les		
Precious metal (e.g. Ag,Au, NiPdAu) (n Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no CU Alloy Sn)		1		260		C	30		seconds 3				
Comments														
evel 1 - maximum time at peak temperature duri	ng soldering is 10-3	0 seconds												
for more information regarding material composition	sition please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl shthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.66	mg	Supplier	Silicon (Si)	7440-21-3		1.66	mg
Die Attach	0.18	mg	Supplier	Silver (Ag)	7440-22-4		0.135	mg
			Supplier	Epoxy resins	129915-35-1		0.045	mg
Lead Frame 10	10.12	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0152	mg
			Supplier	Silicon (Si)	7440-21-3		0.0658	mg
			В	Nickel (Ni)	7440-02-0		0.3036	mg
			Supplier	Copper (Cu)	7440-50-8		9.7354	mg
Mold Compound-Black	12.98	mg		Epoxy Phenol Resin	proprietary data		1.3629	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.6171	mg
Plating	0.17	mg	Supplier	Palladium (Pd)	7440-05-3		0.0106	mg
			В	Nickel (Ni)	7440-02-0		0.1576	mg
			Supplier	Gold (Au)	7440-57-5		0.0018	mg
Wire Bond - Au	0.16	mg	Supplier	Gold (Au)	7440-57-5		0.16	mg